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Amendment to the Claims

Please amend claims 24, 27 and 30-31 as follows:

1 (Original): A plasma immersion ion implant apparatus comprising:

a plasma chamber configured to receive a process gas;

a radio frequency (RF) source configured to resonate radio frequency currents in a

radio frequency antenna;

a radio frequency antenna including an active antenna surrounding the plasma

chamber and coupled to the RF source and a parasitic antenna surrounding the

plasma chamber and not directly coupled to any RF source; and

a platen for holding a target,

wherein electro-magnetic fields induced by the radio frequency currents are

effective to pass into the plasma chamber and excite and ionize the process gas to

generate plasma within the plasma chamber.

2 (Original): The apparatus of claim 1, wherein the active antenna includes a

horizontally-extending coil and the parasitic antenna includes a vertically-

extending coil.

3 (Original): The apparatus of claim 1, wherein the active antenna includes a

vertically-extending coil and the parasitic antenna includes a horizontally-

extending coil.

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(Original): The apparatus of claim 1, wherein the parasitic antenna includes a

plurality of turns with one end grounded.

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- Original): The apparatus of claim 4, further comprising means for adjusting a number of turns of the parasitic antenna providing a parasitic effect.
- 6 (Withdrawn): The apparatus of claim 1, wherein the parasitic antenna includes a plurality of turns with both ends floating.
- 7 (Original): The apparatus of claim 1, wherein an inner diameter of each antenna is greater than a size of the target.
- 8 (Original): The apparatus of claim 1, wherein the parasitic antenna is above and coaxial with the active antenna.
- 9 (Original): The apparatus of claim 1, wherein at least one antenna is liquid cooled.
- 10 (Original): The apparatus of claim 9, wherein the parasitic antenna is coupled to the plasma chamber via a thermally conductive elastomer.
- 11 (Original): The apparatus of claim 1, wherein the plasma chamber includes:
 a horizontal planar section positioned above the platen;
 a vertical cylindrical section extending from the horizontal planar section; and
 a top section coupled to the vertical cylindrical section.
- (Original): The apparatus of claim 11, wherein the horizontal planar section and vertical cylindrical section are dielectric, and the top section is conductive and grounded.
- 13 (Original): The apparatus of claim 12, wherein the horizontal planar section and vertical cylindrical section are formed of a high purity ceramic material.

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- 14 (Original): The apparatus of claim 13, wherein the high purity ceramic material is >99.6% Al₂O₃, AlN, Yittria or YAG.
- 15 (Original): The apparatus of claim 12, wherein the top section is formed of Al.
- 16 (Original): The apparatus of claim 11, wherein the top section is liquid cooled.
- 17 (Original): The apparatus of claim 1, further comprising a plasma igniter for introducing a strike gas into the plasma chamber to assist in igniting a plasma.
- (Original): The apparatus of claim 1, further comprising a gas source controller for maintaining a pressure of the plasma chamber at a predetermined value.
- 19 (Original): The apparatus of claim 1, wherein the RF source operates at a low RF frequency.
- 20 (Original): The apparatus of claim 19, wherein the low RF frequency is less than 27 MHz.
- 21 (Original): The apparatus of claim 19, wherein the low RF frequency is 400 KHz, 2 MHz, 4 MHz or 13.56 Mhz.
- 22 (Withdrawn): A method of plasma immersion ion implantation, the method comprising the steps of:

generating an ionic plasma by exposing a process gas to a radio frequency (RF) source via a first active coil;

tuning the ionic plasma by parasitically damping via a second parasitic coil that is not connected to any RF source; and

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implanting a target using the ionic plasma by providing a negative voltage to the target.

- 23 (Withdrawn): The method of claim 22, wherein the generating step further includes introducing a strike gas to the RF source.
- 24 (Amended): A plasma chamber comprising:
 - a horizontal planar dielectric section for positioning above a platen;
 - a vertical cylindrical dielectric section extending from the horizontal planar

section; and

a liquid cooled top conductive section coupled to the vertical dielectric section;

<u>and</u>

a radio frequency antenna including a horizontally-extending coil positioned proximate to the horizontal planar dielectric section and a vertically-extending coil positioned proximate to the vertical cylindrical dielectric section, the radio frequency antenna inducing radio frequency currents into the plasma chamber that excite and ionize a process gas so as to generate a plasma in the plasma chamber.

- 25 (Original): The plasma chamber of claim 24, wherein the top conductive section is grounded.
- 26 Canceled.
- 27 (Amended): The plasma chamber of claim 24, wherein the <u>vertically-extending</u>

 <u>coil vertical dielectric section is configured to couple to, via a thermally</u>

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conductive elastomer, comprises a parasitic antenna that is not coupled to any radio frequency (RF) source.

- 28 (Original): The plasma chamber of claim 27, wherein the parasitic antenna includes a plurality of turns with one end grounded.
- 29 (Original): The plasma chamber of claim 28, further comprising means for adjusting a number of turns of the parasitic antenna providing a parasitic effect.
- 30 (Amended): The plasma chamber of claim <u>2427</u>, wherein the <u>radio frequency</u> antenna is liquid cooled.
- (Amended): The plasma chamber of claim 24, wherein the <u>horizontally-extending coil horizontal dielectric section is configured to support comprises</u> an active radio frequency antenna that is coupled to a radio frequency (RF) source.
- 32 (Original): The plasma chamber of claim 24, further comprising a process gas inlet and a strike gas inlet.